2SD2000

Silicon NPN triple diffusion planar type

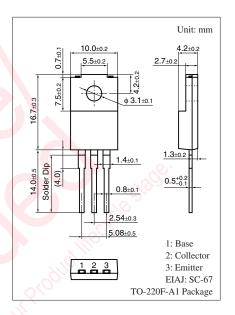
For power switching

■ Features

- High-speed switching
- Satisfactory linearity of forward current transfer ratio h_{FE}
- Large collector power dissipation P_C
- Full-pack package which can be installed to the heat sink with one screw.

■ Absolute Maximum Ratings $T_C = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V_{CBO}	80	V	
Collector-emitter voltage (Base open)	V_{CEO}	60	V	
Emitter-base voltage (Collector open)	V_{EBO}	6	V	
Collector current	I_{C}	4	A	
Peak collector current	I_{CP}	8	A	
Base current	I_{B}	1	A	
Collector power	P _C	35	W	
dissipation $T_a = 25^{\circ}C$		2.0	100	
Junction temperature	T_{j}	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C C	



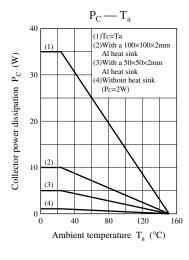
■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

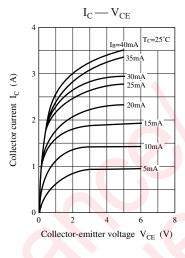
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 25 \text{ mA}, I_B = 0$	60)·		V
Base-emitter voltage	V_{BE}	$V_{CE} = 4 \text{ V}, I_{C} = 4 \text{ A}$	160		2.0	V
Collector-base cut-off current (Emitter open)	I_{CBO}	$V_{CB} = 80 \text{ V}, I_{E} = 0$			100	μΑ
Emitter-base cut-off current (Collector open)	I_{EBO}	$V_{EB} = 6 \text{ V}, I_{C} = 0$			100	μΑ
Forward current transfer ratio	h _{FE1} *	$V_{CE} = 4 \text{ V}, I_{C} = 1 \text{ A}$	70		250	_
	h _{FE2}	$V_{CE} = 4 \text{ V}, I_{C} = 4 \text{ A}$	20			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 4 \text{ A}, I_B = 0.4 \text{ A}$			1.5	V
Transition frequency	f_T	$V_{CE} = 12 \text{ V}, I_{C} = 0.2 \text{ A}, f = 10 \text{ MHz}$		80		MHz
Turn-on time	t _{on}	$I_C = 4 \text{ A}, I_{B1} = 0.4 \text{ A}, I_{B2} = -0.4 \text{ A},$		0.3		μs
Storage time	t _{stg}	$V_{CC} = 50 \text{ V}$		1.0		μs
Fall time	t _f			0.2		μs

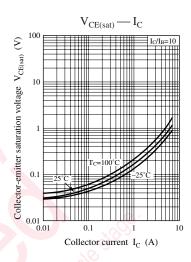
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

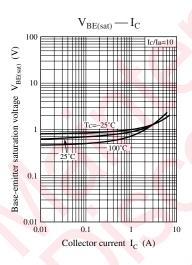
2. *: Rank classification

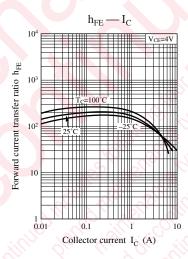
Rank	Q	Р		
h _{FE1}	70 to 150	120 to 250		

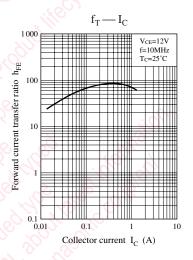


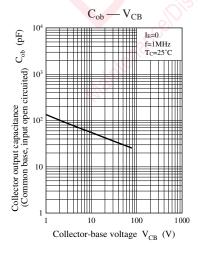


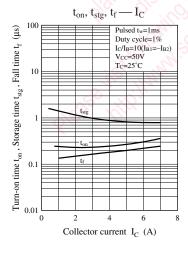


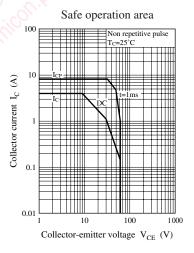




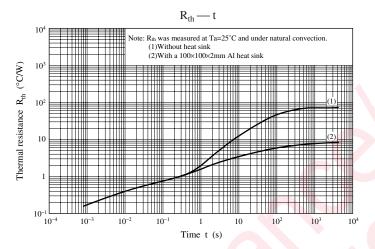








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